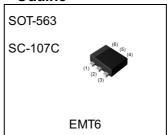


Complex Digital Transistors (Bias Resistor Built-in Transistors)

Parameter	DTr1 and DTr2	
V _{CC}	50V	
I _{C(MAX.)}	100mA	
R ₁	4.7kΩ	
R ₂	47kΩ	

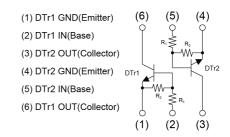
Outline



Features

- 1) Two DTC043Z chips in a EMT package.
- 2)Mounting possible with EMT3 automatic mounting machines.
- 3)Transistor elements are independent, eliminating interference.
- 4) Mounting cost and area can be cut in half.

•Inner circuit



Application

SWITCHING CIRCUIT, INVERTER CIRCUIT, INTERFACE CIRCUIT

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
EMH75	SOT-563 (EMT6)	1616	T2R	180	8	8000	H75

● Absolute maximum ratings (T_a = 25°C)

<For DTr1 and DTr2 in common>

Parameter	Symbol	Values	Unit	
Supply voltage	V_{CC}	50	V	
Input voltage	V _{IN}	30 to -5	V	
Output current	Io	100	mA	
Collector current	I _{C(MAX)} *1	100	mA	
Power dissipation	P _D *2*3	150	mW/TOT	AL
Junction temperature	T _j	150	°C	
Range of storage temperature	T _{stg}	-55 to +150	°C	

● Electrical characteristics (T_a = 25°C)

<For DTr1 and DTr2 in common>

Davameter	Cymab al	Canditions	Values			11.2	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Innutualizara	$V_{I(off)}$	$V_{CC} = 5V, I_{O} = 100 \mu A$	-	-	0.5	- v	
Input voltage	V _{I(on)}	V _O = 0.3V, I _O = 5mA	1.1	-	-		
Output voltage	V _{O(on)}	I _O = 5mA, I _I = 0.5mA	-	50	150	mV	
Input current	I _I	V _I = 5V	-	-	1.8	mA	
Output current	I _{O(off)}	V _{CC} = 50V, V _I = 0V	-	-	500	nA	
DC current gain	G _I	V _O = 10V, I _O = 5mA	80	-	-	-	
Input resistance	R ₁	-	3.29	4.7	6.11	kΩ	
Resistance ratio	R ₂ /R ₁	-	8	10	12	-	
Transition frequency	f _T	V _{CE} = 10V, I _E = -5mA, f = 100MHz	-	250	-	MHz	

^{*1} Characteristics of built-in transistor.

^{*2} Each terminal mounted on a reference land.

^{*3 120}mW per element must not be exceeded.

● Electrical characteristic curves (T_a = 25°C)

<For DTr1 and DTr2 in common>

Fig.1 Input voltage vs. output current (ON characteristics)

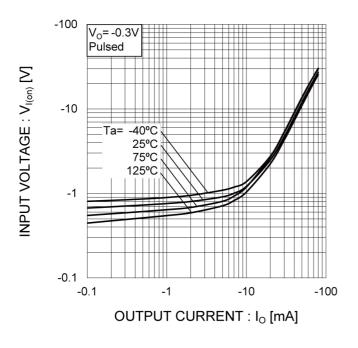


Fig.2 Output current vs. input voltage (OFF characteristics)

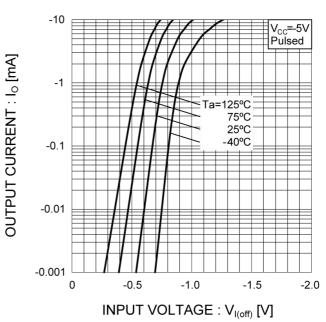


Fig.3 Output current vs. output voltage

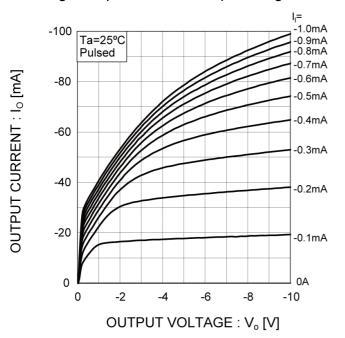
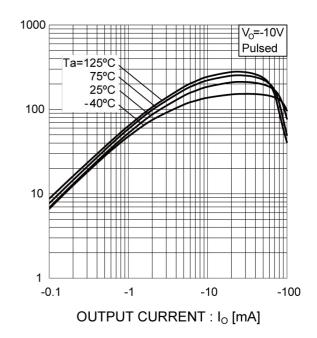


Fig.4 DC current gain vs. output current

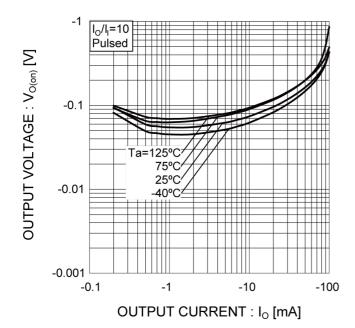


DC CURRENT GAIN: G

●Electrical characteristic curves (T_a = 25°C)

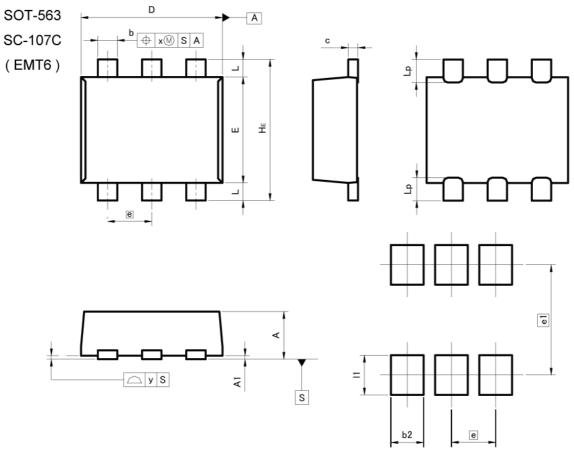
<For DTr1 and DTr2 in common>

Fig.5 Output voltage vs. output current





Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

	MILIM	ETERS	INC	UE6	
DIM	IVITETIVI	ETERS	INCHES		
Diw	MIN	MAX	MIN	MAX	
Α	0.45	0.55	0.018	0.022	
A1	0.00	0.10	0.000	0.004	
b	0.17	0.27	0.007	0.011	
С	0.08	0.18	0.003	0.007	
D	1.50	1.70	0.059	0.067	
E	1.10	1.30	0.043	0.051	
е	0.	50	0.020		
HE	1.50	1.70	0.059	0.067	
L	0.10	0.30	0.004	0.012	
Lp	_	0.35	_	0.014	
х	-	0.10	_	0.004	
У	_	0.10	-	0.004	

	DIM	MILIM	ETERS	INCHES		
DIM		MIN	MAX	MIN	MAX	
	b2	_	- 0.37		0.015	
	e1	1.25		0.049		
	- 11	-	0.45	-	0.018	

Dimension in mm/inches



Notice

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JAPAN	USA	EU	CHINA	
CLASSⅢ	CLACCIII	CLASS II b	CL A C C TT	
CLASSIV	CLASSII	CLASSⅢ	CLASSⅢ	

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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
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 - [h] Use of the Products in places subject to dew condensation
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- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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